



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of)	
)	Examiner: Unassigned
Ravkin et al.)	
)	Art Unit: 2812
Application No: 10/607,611)	
)	Docket No: LAM2P428
Filed: June 27, 2003)	
)	Date: November 12, 2003
For: APPARATUS AND METHOD FOR)	
DEPOSITING AND PLANARIZING THIN FILMS))	
OF SEMICONDUCTOR WAFERS)	

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450, on November 12, 2003.

Signed: _____

Kay Harlow
Kay Harlow

REQUEST FOR CORRECTED FILING RECEIPT

Mail Stop **Application Number**
Commissioner for Patents
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Alexandria, VA 22313-1450

Sir:

Enclosed is a copy of the Filing Receipt for the above-identified patent application. Please reprint the Filing Receipt as follows and mail the corrected copy to the undersigned.

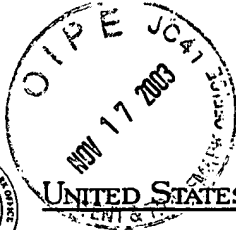
Change the inventor John Boyd's city name from "Ataseadero" to -- Atascadero --.

Since this is a Patent Office typographical error, no fee should be due. However, the Commissioner is authorized to charge any fees that may be due to Deposit Account 50-0805 (Order No. LAM2P428).

Respectfully submitted,
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/607,611	06/27/2003	2812	1092	LAM2P428	10	39	3

CONFIRMATION NO. 8016

FILING RECEIPT



OC000000010906468

25920
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 SUNNYVALE, CA 94085

Date Mailed: 09/22/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Assignment For Published Patent Application

Lam Research Corp., Fremont, CA;

Domestic Priority data as claimed by applicant

This application is a CIP of 10/330,843 12/24/2002
 which is a CIP of 10/261,839 09/30/2002

Foreign Applications

If Required, Foreign Filing License Granted: 09/22/2003

Projected Publication Date: Request for Non-Publication Acknowledged

Non-Publication Request: Yes

Early Publication Request: No

Title

Apparatus and method for depositing and planarizing thin films of semiconductor wafers

Preliminary Class

438

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Title 37, Code of Federal Regulations, 5.11 & 5.15**

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